



TCAN1046-Q1

JAJSJR1A - MARCH 2020 - REVISED SEPTEMBER 2020

# TCAN1046-Q1 車載用、フォルト保護、デュアル CAN FD トランシーバ、 スタンバイ・モード付き

## 1 特長

- AEC-Q100: 車載アプリケーション認定済み
  - 温度グレード 1:-40℃~125℃、T<sub>A</sub>
- モード制御を備えた2つの独立した高速CANFDト ランシーバ
- ISO 11898-2:2016 および ISO 11898-5:2007 物理 層規格の要件に適合
- Classical CAN のサポートと最適化された CAN FD 性能 (2、5、8Mbps)
  - 短く対称的な伝搬遅延時間によりタイミング・マージ
  - 負荷のある CAN ネットワークでより高いデータ・レ ートを実現
- の I/O 電圧範囲は 1.7V~5.5V をサポート
  - 1.8V、2.5V、3.3V、5V のアプリケーションをサポー 1
- 保護機能:
  - バス・フォルト保護:±58V
  - 低電圧保護
  - TXD ドミナント・タイムアウト (DTO)
    - 最低 9.2kbps のデータ・レート
  - サーマル・シャットダウン保護 (TSD)
- 動作モード:
  - 通常モード
  - リモート・ウェイクアップ要求をサポートする、低消費 電力スタンバイ・モード
- 電源非接続時の最適化された挙動
  - バスおよびロジック端子は高インピーダンス (動作 中のバスやアプリケーションに対して無負荷)
  - 活線挿抜対応:バスおよび RXD 出力において電 源オン/オフ時のグリッチのない動作
- 接合部温度範囲:-40℃~150℃
- レシーバの同相入力電圧:±12V
- SOIC (14) パッケージ、自動光学検査 (AOI) 性能を 向上させたリードレス VSON (14) パッケージ (4.5mm × 3.0mm) で供給

### 2 アプリケーション

- 車両および輸送システム
  - 車体制御モジュール
  - 車載ゲートウェイ
  - 先進運転支援システム (ADAS)
  - インフォテインメント

## 3 概要

TCAN1046-Q1 (TCAN1046) は、ISO 11898-2:2016 高 速 CAN (Controller Area Network) 仕様の物理層要件 を満たすデュアル高速 CAN トランシーバです。

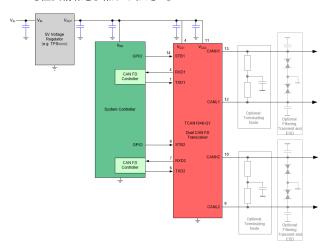
TCAN1046 は Classical CAN ネットワークおよび最高 8 メガビット/秒 (Mbps) の CAN FD ネットワークの両方に対 応しています。このデバイスには 2 つの CAN FD チャネ ルがあり、独立した電源 ( $V_{CC1}$  と  $V_{CC2}$ ) とモード制御 (STB1 ピンと STB2 ピン) を備えているため、各 CAN チ ャネルは完全に独立して動作できます。各チャネルが互 いに独立して動作できることは、冗長性が要求されるアプ リケーションや、システム障害時にバックアップとして追加 の CAN FD チャネルが動作する必要があるアプリケーシ ョンにおいて重要です。

TCAN1046 は、サーマル・シャットダウン (TSD)、TXDドミ ナント・タイムアウト (DTO)、最高 ±58V のバス・フォルト保 護を含む多くの保護および診断機能も備えています。

## 製品情報

部品番号	パッケージ <sup>(1)</sup>	本体サイズ (公称)
TCAN1046-Q1	VSON (DMT) (14)	4.50mm × 3.00mm
	SOIC (D) (14)	8.95mm × 3.91mm

利用可能なパッケージについては、このデータシートの末尾にあ る注文情報を参照してください。



概略回路図



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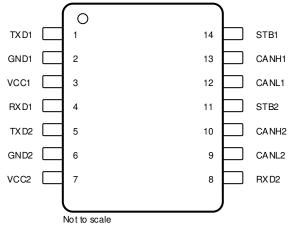
## **4 Revision History**

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

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## **5 Pin Configuration and Functions**





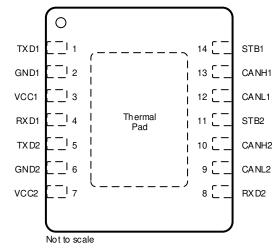


図 5-2. DMT Package TCAN1046-Q1, 14 Pin VSON, Top View

### **Pin Functions**

Pin	s	Tyme	Description		
Name	No.	Туре	Description		
TXD1	1	Digital Input	CAN transmit data input 1, integrated pull-up		
GND1	2	GND1	Ground connection, transceiver 1		
V <sub>CC1</sub>	3	Supply	5-V supply voltage, transceiver 1		
RXD1	4	Digital Output	CAN receive data output 1, tri-state when V <sub>CC</sub> < UV <sub>VCC</sub>		
TXD2 5 Digital Input CAN transmit data input 2, integrated pull-up					
GND2	6	GND2	Ground connection, transceiver 2		
V <sub>CC2</sub>	7	Supply	5-V supply voltage, transceiver 2		
RXD2	8	Digital Output	CAN receive data output 2, tri-state when V <sub>CC</sub> < UV <sub>VCC</sub>		
CANL2	9	Bus IO	Low-level CAN bus 2 input/output line		
CANH2	10	Bus IO	High-level CAN bus 2 input/output line		
STB2	11	Digital Input	Standby input 2 for mode control, integrated pull-up		
CANL1	12	Bus IO	Low-level CAN bus 1 input/output line		
CANH1	13	Bus IO	High-level CAN bus 1 input/output line		
STB1	14	Digital Input	Standby input 1 for mode control, integrated pull-up		
Thermal Pad (VSON only) —		_	Electrically connected to GND, connect the thermal pad to the printed circuit board (PCB) ground plane for thermal relief		



## **6 Specifications**

## **6.1 Absolute Maximum Ratings**

over operating free-air temperature range (unless otherwise noted)(1) (2)

		MIN	MAX	UNIT
V <sub>CC1</sub> , V <sub>CC2</sub>	Supply voltage	-0.3	6	V
V <sub>BUS</sub>	CAN Bus IO voltage CANH1, CANL1 & CANH2, CANL2	-58	58	V
V <sub>DIFF</sub>	Max differential voltage between CANH1, CANL1 & CANH2, CANL2	-45	45	V
V <sub>Logic_Input</sub>	Logic input terminal voltage	-0.3	6	V
V <sub>RXD</sub>	RXD output terminal voltage range (V <sub>RXD1</sub> , V <sub>RXD2</sub> )	-0.3	6	V
I <sub>O(RXD)</sub>	RXD output current (I <sub>ORXD1</sub> , I <sub>ORXD2</sub> )	-8	8	mA
T <sub>J</sub>	Operating virtual junction temperature range	-40	150	°C
T <sub>STG</sub>	Storage temperature	-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

				VALUE	UNIT
V <sub>ESD</sub> Elec		Human-body model (HBM), per AEC Q100-002 <sup>(1)</sup>	HBM classification level 3A for all pins	±3000	V
	Electrostatic discharge	7	HBM classification level 3B for global pins CANH & CANL	±10000	V
		Charged-device model (CDM), per AEC Q100-011 CDM classification level C5 for all pins		±750	V

<sup>(1)</sup> AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### **6.3 Recommended Operating Conditions**

		MIN	NOM	MAX	UNIT
V <sub>CC1</sub> , V <sub>CC2</sub>	Supply voltage	4.5	5	5.5	V
I <sub>OH(RXD)</sub>	RXD terminal high level output current – I <sub>OH(RXD1)</sub> & I <sub>OH(RXD2)</sub>	-2			mA
I <sub>OL(RXD)</sub>	RXD terminal low level output current – I <sub>OL(RXD1)</sub> & I <sub>OL(RXD2)</sub>			2	mA
T <sub>A</sub>	Operating ambient temperature	-40		125	°C

### **6.4 Thermal Characteristics**

	THERMAL METRIC <sup>(1)</sup>	TCAN1	1046-Q1	UNIT
	THERMAL METRIC	D (SOIC)	DMT (VSON)	UNII
$R_{\theta JA}$	Junction-to-ambient thermal resistance	70.6	35.5	°C/W
R <sub>θJC(top)</sub>	Junction-to-case (top) thermal resistance	33.4	38.1	°C/W
R <sub>θJB</sub>	Junction-to-board thermal resistance	34.0	13.4	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	5.0	1.9	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	32.6	13.4	°C/W
R <sub>0</sub> JC(bot)	Junction-to-case (bottom) thermal resistance	-	3.5	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

Product Folder Links: TCAN1046-Q1

<sup>(2)</sup> All voltage values, except differential IO bus voltages, are with respect to ground terminal.

## 6.5 Supply Characteristics

Over recommended operating conditions with  $T_A = -40$ °C to 125°C (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
1.		Dominant	TXD = 0 V, STB = 0 V, R <sub>L</sub> = 60 $\Omega$ , C <sub>L</sub> = open See $\boxtimes$ 7-1		45	70	mA
	Supply current Normal mode	Dominant	TXD = 0 V, STB = 0 V, R <sub>L</sub> = 50 $\Omega$ , C <sub>L</sub> = open See $\boxtimes$ 7-1		49	80	mA
Icc	Per transceiver	Recessive	TXD = $V_{CC}$ , STB = 0 V, $R_L$ = 50 $\Omega$ , $C_L$ = open See $\boxtimes$ 7-1		4.5	7.5	mA
		Dominant with bus fault	TXD = 0 V, STB = 0 V, CANH = CANL = $\pm 25$ V, R <sub>L</sub> = open, C <sub>L</sub> = open See $\boxtimes$ 7-1			130	mA
I <sub>cc</sub>	Supply current Standby mode Per transceiver		TXD = STB = $V_{CC}$ , $R_L$ = 50 $\Omega$ , $C_L$ = open See $\boxtimes$ 7-1			14.5	μА
UV <sub>VCC</sub>	Rising under voltage detect	ion on V <sub>CC</sub> for prot	n on V <sub>CC</sub> for protected mode		4.2	4.4	V
UV <sub>VCC</sub>	Falling under voltage detect	tion on V <sub>CC</sub> for prot	ected mode	3.5	4	4.25	V

## 6.6 Dissipation Ratings

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	25	$V_{CC}$ = 5 V, T <sub>J</sub> = 27°C, R <sub>L</sub> = 60Ω, TXD input = 250 kHz 50% duty cycle squarewave, $C_{L\_RXD}$ = 15 pF		110		mW
		$V_{CC}$ = 5 V, T <sub>J</sub> = 27°C, R <sub>L</sub> = 60 $\Omega$ , TXD input = 250 kHz 50% duty cycle squarewave, $C_{L\_RXD}$ = 15 pF		110		mW
	Average power dissipation Normal mode	$V_{\rm CC}$ = 5 V, T <sub>J</sub> = 27°C, R <sub>L</sub> = 60 $\Omega$ , TXD input = 250 kHz 50% duty cycle squarewave, C <sub>L_RXD</sub> = 15 pF		110		mW
P <sub>D</sub>	Per transceiver	$V_{\rm CC}$ = 5.5 V, $T_{\rm A}$ = 125°C, $R_{\rm L}$ = 60 $\Omega$ , TXD input = 2.5 MHz 50% duty cycle squarewave, $C_{\rm L\_RXD}$ = 15 pF		120		mW
		$V_{\rm CC}$ = 5.5 V, $T_{\rm A}$ = 125°C, $R_{\rm L}$ = 60Ω, TXD input = 2.5 MHz 50% duty cycle squarewave, $C_{\rm L\_RXD}$ = 15 pF		120		mW
		$V_{CC}$ = 5.5 V, $T_A$ = 125°C, $R_L$ = 60Ω, TXD input = 2.5 MHz 50% duty cycle squarewave, $C_{L\_RXD}$ = 15 pF		120		mW
T <sub>TSD</sub>	Thermal shutdown temperature <sup>(1)</sup>		170	192	205	°C
T <sub>TSD_HYS</sub>	Thermal shutdown hysteresis			10		J

<sup>(1)</sup> Specified by design

### **6.7 Electrical Characteristics**

Over recommended operating conditions with  $T_A = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  (unless otherwise noted); CAN electrical parameters apply to both channels

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT			
Driver Elec	Driver Electrical Characteristics									
	Dominant output voltage	CANH	TXD = 0 V, STB = 0 V , 50 $\Omega \le R_L \le 65 \Omega$ ,	2.75		4.5	V			
V <sub>O(DOM)</sub>	Normal mode	CANL	C <sub>L</sub> = open, R <sub>CM</sub> = open See ⊠ 7-2 and ⊠ 8-3,	0.5		2.25	٧			
V <sub>O(REC)</sub>	Recessive output voltage Normal mode	CANH and CANL	$\begin{aligned} &TXD = V_{CC}, STB = 0 \; V \;, \; R_{L} = open \; (no \\ &load), \; R_{CM} = open \\ &See \; \boxtimes \; 7\text{-2} \; and \; \boxtimes \; 8\text{-3} \end{aligned}$	2	0.5 V <sub>CC</sub>	3	V			
V <sub>SYM</sub>	Driver symmetry (V <sub>O(CANH)</sub> + V <sub>O(CANL)</sub> )/V <sub>CC</sub>		STB = 0 V , R <sub>L</sub> = 60 $\Omega$ , C <sub>SPLIT</sub> = 4.7 nF, C <sub>L</sub> = open, R <sub>CM</sub> = open, TXD = 250 kHz, 1 MHz, 2.5 MHz See $\boxtimes$ 7-2 and $\boxtimes$ 9-2	0.9		1.1	V/V			



## 6.7 Electrical Characteristics (continued)

Over recommended operating conditions with  $T_A$  = -40°C to 125°C (unless otherwise noted); CAN electrical parameters apply to both channels

	PARAMETER		TEST CONDITIONS	MIN	TYP MA	X UNIT
V <sub>SYM_DC</sub>	DC output symmetry (V <sub>CC</sub> - V <sub>O(CANL)</sub> )		STB = 0 V , $R_L$ = 60 $\Omega$ , $C_L$ = open See $\boxtimes$ 7-2 and $\boxtimes$ 8-3	-400	40	0 mV
			$TXD = 0 \text{ V, STB} = 0 \text{ V, } 50  \Omega \leq R_L \leq 65  \Omega,$ $C_L = \text{open}$ $\text{See} \boxtimes 7\text{-2 and } \boxtimes 8\text{-3}$	1.5		3 V
/OD(DOM)  /OD(DOM)  /OD(REC)  /O(STB)  OS(SS_DOM)  OS(SS_REC)  Receiver Elec  /IT  /IT(STB)  /DOM  /REC  /DOM(STB)  /REC(STB)  /HYS  /CM  LKG(OFF)	Differential output voltage Normal mode Dominant	CANH - CANL	TXD = 0 V, STB = 0 V, 45 $\Omega$ $\leq$ R <sub>L</sub> $\leq$ 70 $\Omega$ , C <sub>L</sub> = open See $\boxtimes$ 7-2 and $\boxtimes$ 8-3	1.4	3	3 V
			TXD = 0 V, STB = 0 V, R <sub>L</sub> = 2240 $\Omega$ , C <sub>L</sub> = open See $\boxtimes$ 7-2 and $\boxtimes$ 8-3	1.5		5 V
V	Differential output voltage Normal mode	CANH - CANL	TXD = $V_{CC}$ , STB = 0 V , $R_L$ = 60 Ω, $C_L$ = open See $\boxtimes$ 7-2 and $\boxtimes$ 8-3	-120	1	2 mV
VOD(REC)	Recessive	CANIT - CANE	TXD = $V_{CC}$ , STB = 0 V , $R_L$ = open, $C_L$ = open See $\boxtimes$ 7-2 and $\boxtimes$ 8-3	-50	Ę	0 mV
		CANH		-0.1	0	1 V
V <sub>O(STB)</sub>	Bus output voltage Standby mode	CANL	STB = V <sub>CC</sub> , R <sub>L</sub> = open (no load) See ⊠ 7-2 and ⊠ 8-3	-0.1	0	1 V
	Starraby mode	CANH - CANL	Soo M 1-2 unu M 0-0	-0.2	0	2 V
	Short-circuit steady-state ou	tput current,	STB = 0 V , V <sub>(CANH)</sub> = -15 V to 40 V, CANL = open, TXD = 0 V See 🗵 7-7 and 🗵 8-3	<b>–115</b>		mA
IOS(SS_DOM)	dominant Normal mode		STB = 0 V , V <sub>(CAN L)</sub> = -15 V to 40 V, CANH = open, TXD = 0 V See ⊠ 7-7 and ⊠ 8-3		1	
I <sub>OS(SS_REC)</sub>	Short-circuit steady-state output current, recessive Normal mode		STB = 0 V , $-27$ V $\leq$ V <sub>BUS</sub> $\leq$ 32 V, where V <sub>BUS</sub> = CANH = CANL, TXD = V <sub>CC</sub> See $\boxtimes$ 7-7 and $\boxtimes$ 8-3	-5		5 mA
Receiver Ele	ectrical Characteristics					
V <sub>IT</sub>	Input threshold voltage Normal mode		STB = 0 V , -12 V ≤ V <sub>CM</sub> ≤ 12 V See ☑ 7-3, ☑ 7-3, and 表 8-5	500	90	0 mV
V <sub>IT(STB)</sub>	Input threshold Standby mode		STB = V <sub>CC</sub> See 表 8-5	400	115	0 mV
$V_{DOM}$	Dominant state differential in Normal mode	nput voltage range	STB = 0 V , -12 V ≤ $V_{CM}$ ≤ 12 V See $\boxtimes$ 7-3, and $₹$ 8-5	0.9		9 V
V <sub>REC</sub>	Recessive state differential i Normal mode	nput voltage range	STB = 0 V , -12 V ≤ $V_{CM}$ ≤ 12 V See $\boxtimes$ 7-3, and $₹$ 8-5	-4	0	5 V
V <sub>DOM(STB)</sub>	Dominant state differential in Standby mode	nput voltage range	STB = $V_{CC}$ , -12 V ≤ $V_{CM}$ ≤ 12 V See $\frac{1}{2}$ 8-5	1.15		9 V
V <sub>REC(STB)</sub>	Recessive state differential i Standby mode	nput voltage range	STB = $V_{CC}$ , -12 V ≤ $V_{CM}$ ≤ 12 V See $\frac{1}{2}$ 8-5	-4	0	4 V
V <sub>HYS</sub>	Hysteresis voltage for input Normal mode	threshold	STB = 0 V , -12 V ≤ $V_{CM}$ ≤ 12 V See $\boxtimes$ 7-3, and $\bigotimes$ 8-5		100	mV
V <sub>CM</sub>	Common mode range Normal and standby modes		See 図 7-3 and 表 8-5	-12		2 V
I <sub>LKG(OFF)</sub>	Unpowered bus input leakag	ge current	CANH = CANL = 5 V, V <sub>CC</sub> = GND			5 μA
Cı	Input capacitance to ground	(CANH or CANL)	TXD = V <sub>CC</sub>			0 pF
C <sub>ID</sub>	Differential input capacitano	e	- 00			0 pF
R <sub>ID</sub>	Differential input resistance		- TXD = V <sub>CC</sub> , STB = 0 V , -12 V ≤ V <sub>CM</sub> ≤ 12	40		0 kΩ
R <sub>IN</sub>	Single ended input resistand (CANH or CANL)	ce	V VCC, 015 0 V, 12 V = VCM = 12	20	4	5 kΩ
R <sub>IN(M)</sub>	Input resistance matching [1 – (R <sub>IN(CANH)</sub> / R <sub>IN(CANL)</sub> )] >	< 100 %	$V_{(CAN\_H)} = V_{(CAN\_L)} = 5 \text{ V}$	-1		1 %
TXD Termin	al (CAN Transmit Data Input	)				
$V_{IH}$	High-level input voltage			0.7 V <sub>CC</sub>		V

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## **6.7 Electrical Characteristics (continued)**

Over recommended operating conditions with  $T_A = -40^{\circ}\text{C}$  to 125°C (unless otherwise noted); CAN electrical parameters apply to both channels

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>IL</sub>	Low-level input voltage				0.3 V <sub>CC</sub>	V
I <sub>IH</sub>	High-level input leakage current	TXD = V <sub>CC</sub> = 5.5 V	-2.5	0	1	μA
I <sub>IL</sub>	Low-level input leakage current	TXD = 0 V, V <sub>CC</sub> = 5.5 V	-200	-100	-20	μA
I <sub>LKG(OFF)</sub>	Unpowered leakage current	TXD = 5.5 V, V <sub>CC</sub> = 0 V	-1	0	1	μA
Cı	Input Capacitance	$V_{IN} = 0.4 \times \sin(2 \times \pi \times 2 \times 10^6 \times t) + 2.5 \text{ V}$		5		pF
RXD Termi	inal (CAN Receive Data Output)					
V <sub>OH</sub>	High-level output voltage	I <sub>O</sub> = −2 mA, See ⊠ 7-3	0.8 V <sub>CC</sub>			V
V <sub>OL</sub>	Low-level output voltage	I <sub>O</sub> = +2 mA, See ⊠ 7-3			0.2 V <sub>CC</sub>	٧
I <sub>LKG(OFF)</sub>	Unpowered leakage current	RXD = 5.5 V, V <sub>CC</sub> = 0 V	-1	0	1	μA
STB Termi	nal (Standby Mode Input)	,				
V <sub>IH</sub>	High-level input voltage		0.7 V <sub>CC</sub>			V
V <sub>IL</sub>	Low-level input voltage				0.3 V <sub>CC</sub>	V
I <sub>IH</sub>	High-level input leakage current	V <sub>CC</sub> = STB = 5.5 V	-2		2	μA
I <sub>IL</sub>	Low-level input leakage current	V <sub>CC</sub> = 5.5 V, STB = 0 V	-20		-2	μA
I <sub>LKG(OFF)</sub>	Unpowered leakage current	STB = 5.5V, V <sub>CC</sub> = 0 V	-1	0	1	μA

## **6.8 Switching Characteristics**

Over recommended operating conditions with  $T_A$  = -40°C to 125°C (unless otherwise noted); Timing parameters apply to both CAN channels

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Device Switchir	ng Characteristics				'	
t <sub>PROP(LOOP1)</sub>	Total loop delay, driver input (TXD) to receiver output (RXD), recessive to dominant	Normal mode, R <sub>L</sub> = $60~\Omega$ , C <sub>L</sub> = $100~pF$ , C <sub>L(RXD)</sub> = $15~pF$ See $\bowtie$ 7-4		125	210	ns
t <sub>PROP(LOOP2)</sub>	Total loop delay, driver input (TXD) to receiver output (RXD), dominant to recessive	Normal mode, R <sub>L</sub> = $60~\Omega$ , C <sub>L</sub> = $100~pF$ , C <sub>L(RXD)</sub> = $15~pF$ See $\bowtie$ 7-4		150	210	ns
t <sub>MODE</sub>	Mode change time, from normal to standby or from standby to normal	See ⊠ 7-5			20	μs
t <sub>WK_FILTER</sub>	Filter time for a valid wake-up pattern	See 図 8-5	0.5		1.8	μs
twk_TIMEOUT	Bus wake-up timeout	See ⊠ 8-5	0.8		6	ms
Driver Switchin	g Characteristics				'	
t <sub>pHR</sub>	Propagation delay time, high TXD to driver recessive (dominant to recessive) <sup>(1)</sup>		35	80	115	ns
t <sub>pLD</sub>	Propagation delay time, low TXD to driver dominant (recessive to dominant) <sup>(1)</sup>	STB = 0 V , R <sub>L</sub> = 60 Ω, C <sub>L</sub> = 100 pF	20	70	120	ns
t <sub>sk(p)</sub>	Pulse skew ( tpHR - tpLD )	See ⊠ 7-2 and ⊠ 7-6		20		ns
t <sub>R</sub>	Differential output signal rise time			30		ns
t <sub>F</sub>	Differential output signal fall time			50		ns
t <sub>TXD_DTO</sub>	Dominant timeout		1.2		4.0	ms
Receiver Switch	ning Characteristics					
t <sub>pRH</sub>	Propagation delay time, bus recessive input to high output (dominant to recessive) <sup>(1)</sup>		40	90	150	ns
t <sub>pDL</sub>	Propagation delay time, bus dominant input to low output (recessive to dominant) <sup>(1)</sup>	STB = 0 V , C <sub>L(RXD)</sub> = 15 pF See 🗵 7-3	35	65	140	ns
t <sub>R</sub>	RXD output signal rise time	1		10		ns
t <sub>F</sub>	RXD output signal fall time	1		10		ns
(1)FD Timing Ch	aracteristics					-



## **6.8 Switching Characteristics (continued)**

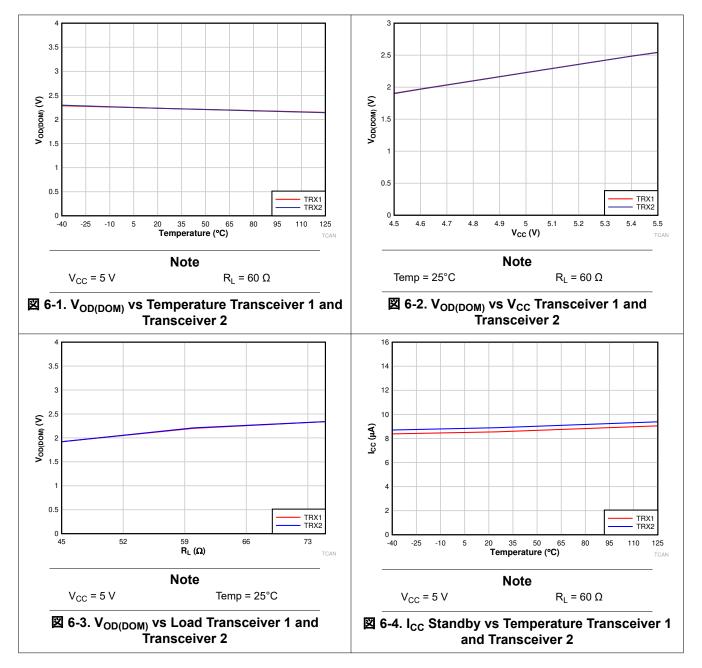
Over recommended operating conditions with  $T_A$  = -40°C to 125°C (unless otherwise noted); Timing parameters apply to both CAN channels

	PARAMETER	TEST CONDITIONS	MIN	TYP MAX	UNIT
t <sub>BIT(BUS)</sub>	Bit time on CAN bus output pins t <sub>BIT(TXD)</sub> = 500 ns		460	510	ns
t <sub>BIT(BUS)</sub>	Bit time on CAN bus output pins t <sub>BIT(TXD)</sub> = 200 ns		160	210	ns
t <sub>BIT(RXD)</sub>	Bit time on RXD output pins t <sub>BIT(TXD)</sub> = 500 ns	STB = 0 V, $R_L$ = 60 $\Omega$ , $C_L$ = 100 pF, $C_{L(RXD)}$ = 15 pF	445	515	ns
t <sub>BIT(RXD)</sub>	Bit time on RXD output pins t <sub>BIT(TXD)</sub> = 200 ns	$\Delta t_{REC} = t_{BIT(RXD)} - t_{BIT(BUS)}$ See $\boxtimes$ 7-4		215	ns
$\Delta t_{REC}$	Receiver timing symmetry t <sub>BIT(TXD)</sub> = 500 ns		-35	15	ns
Δt <sub>REC</sub>	Receiver timing symmetry t <sub>BIT(TXD)</sub> = 200 ns		-35	15	ns

<sup>(1)</sup> Specified by design and characterization

Product Folder Links: TCAN1046-Q1

## 6.9 Typical Characteristics





## 7 Parameter Measurement Information

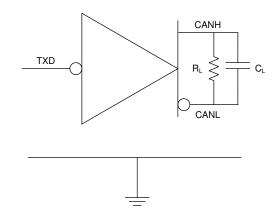


図 7-1. I<sub>CC</sub> Test Circuit

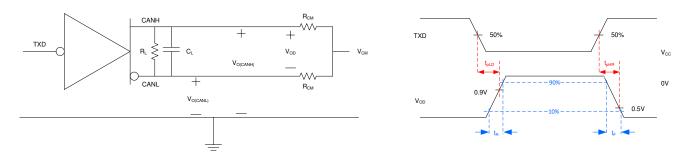


図 7-2. Driver Test Circuit and Measurement

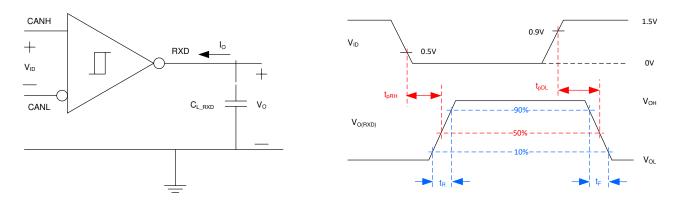


図 7-3. Receiver Test Circuit and Measurement

表 7-1. Receiver Differential Input Voltage Threshold Test

	27 1. Receiver Emerchan input voltage infection received								
	Input (See ⊠ 7-3)		Out	out					
V <sub>CANH</sub>	V <sub>CANL</sub>	V <sub>ID</sub>	RXD						
-11.5 V	-12.5 V	1000 mV							
12.5 V	11.5 V	1000 mV	Low	.,					
-8.55 V	-9.45 V	900 mV	Low	V <sub>OL</sub>					
9.45 V	8.55 V	900 mV							
-8.75 V	-9.25 V	500 mV							
9.25 V	8.75 V	500 mV							
-11.8 V	-12.2 V	400 mV	High	V <sub>OH</sub>					
12.2 V	11.8 V	400 mV							
Open	Open	X							

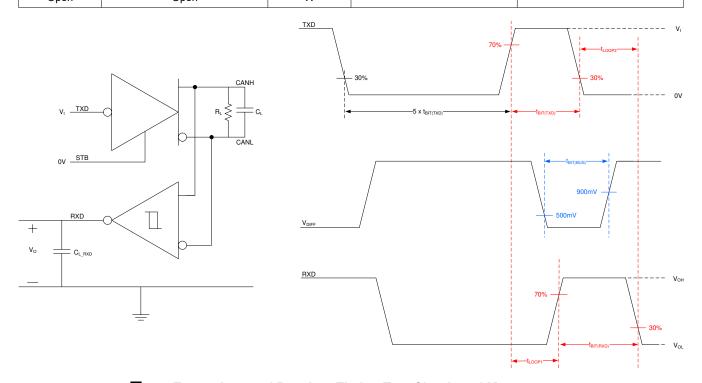


図 7-4. Transmitter and Receiver Timing Test Circuit and Measurement



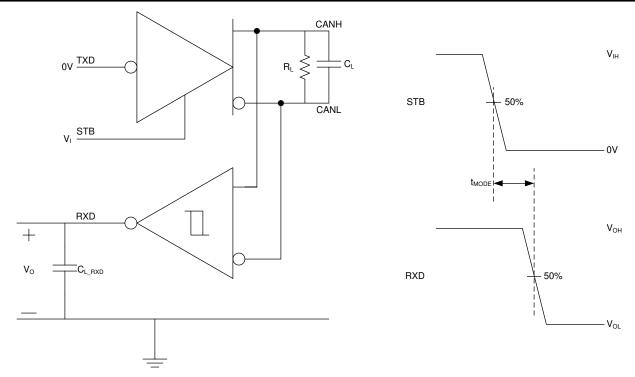


図 7-5. t<sub>MODE</sub> Test Circuit and Measurement

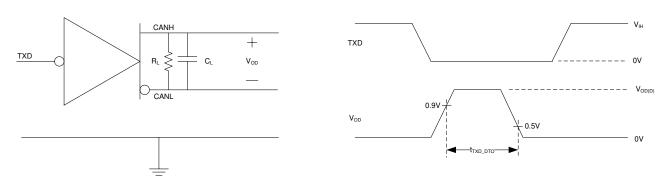


図 7-6. TXD Dominant Timeout Test Circuit and Measurement

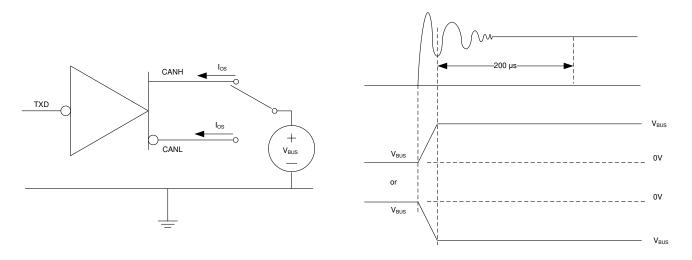


図 7-7. Driver Short-Circuit Current Test and Measurement

## 8 Detailed Description

### 8.1 Overview

The TCAN1046 meets or exceeds the specifications of the ISO 11898-2:2016 high speed CAN (Controller Area Network) physical layer standard. The device has been certified to the requirements of ISO 11898-2:2016 and ISO 11898-5:2007 physical layer requirements according to the GIFT/ICT high speed CAN test specification. The transceiver provides a number of different protection features making it ideal for the stringent automotive system requirements while also supporting CAN FD data rates up to 8 Mbps.

The TCAN1046 conforms to the following CAN standards:

- · CAN transceiver physical layer standards:
  - ISO 11898-2:2016 High speed medium access unit
  - ISO 11898-5:2007 High speed medium access unit with low-power mode
  - SAE J2284-1: High Speed CAN (HSC) for Vehicle Applications at 125 kbps
  - SAE J2284-2: High Speed CAN (HSC) for Vehicle Applications at 250 kbps
  - SAE J2284-3: High Speed CAN (HSC) for Vehicle Applications at 500 kbps
  - SAE J2284-4: High-Speed CAN (HSC) for Vehicle Applications at 500 kbps with CAN FD Data at 2 Mbps
  - SAE J2284-5: High-Speed CAN (HSC) for Vehicle Applications at 500 kbps with CAN FD Data at 5 Mbps
  - ARINC 825-4 General Standardization of CAN (Controller Area Network) Bus Protocol For Airborne Use
- Conformance test requirements:
  - ISO 16845-2 Road vehicles Controller area network (CAN) conformance test plan Part 2: High-speed medium access unit conformance test plan

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## 8.2 Functional Block Diagram

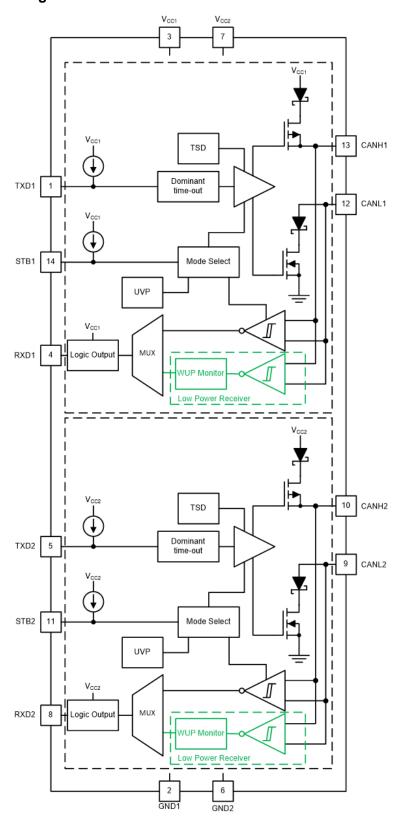


図 8-1. Block Diagram

### 8.3 Feature Description

#### 8.3.1 Pin Description

#### 8.3.1.1 TXD1 and TXD2

TXD1 and TXD2 are the logic-level input signals, referenced to V<sub>CC</sub>, from a CAN controller to the TCAN1046.

#### 8.3.1.2 GND1 and GND2

GND1 and GND2 are ground pins of the transceiver, both must be connected to the PCB ground.

#### 8.3.1.3 $V_{CC1}$ and $V_{CC2}$

 $V_{\text{CC1}}$  and  $V_{\text{CC2}}$  provide the 5-V nominal power supply input to their respective CAN transceiver.

#### 8.3.1.4 RXD1 and RXD2

RXD1 and RXD2 are the logic-level output signals from the TCAN1046 to a CAN controller.

#### 8.3.1.5 CANH1, CANL1, CANH2, and CANL1

These are the CAN high and CAN low differential bus pins. These pins are connected to the CAN transceiver and the low-voltage WUP CAN receiver.

### 8.3.1.6 STB1 and STB2 (Standby)

The STB1 and STB2 are input pins used for mode control of the TCAN1046. STB1 and STB2 can be supplied from either the system processor or from a static system voltage source. If normal mode is the only intended mode of operation than the STB pins can be tied directly to GND.

#### 8.3.2 CAN Bus States

The CAN bus has two logical states during operation: recessive and dominant. See ⊠ 8-2 and ⊠ 8-3.

A dominant bus state occurs when the bus is driven differentially and corresponds to a logic low on the TXD1, TXD2, RXD1 and RXD2 pins. A recessive bus state occurs when the bus is biased to  $V_{CC}/2$  via the high-resistance internal input resistors  $R_{IN}$ ) of the receiver and corresponds to a logic high on the TXD1, TXD2, RXD1 and RXD2 pins.

A dominant state overwrites the recessive state during arbitration. Multiple CAN nodes may be transmitting a dominant bit at the same time during arbitration, and in this case the differential voltage of the bus is greater than the differential voltage of a single driver.

The TCAN1046 transceiver implements a low-power standby (STB) mode which enables a third bus state where the bus pins are weakly biased to ground via the high resistance internal resistors of the receiver. See  $\boxtimes$  8-2 and  $\boxtimes$  8-3.



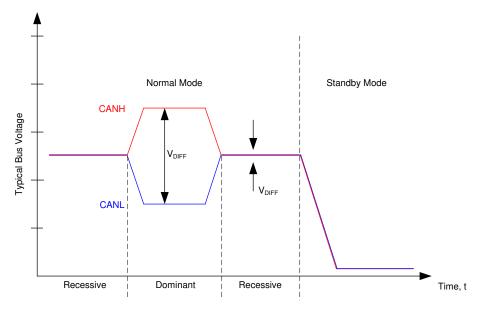
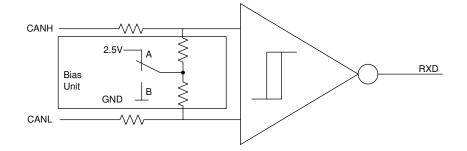


図 8-2. Bus States



- A. Normal Mode
- B. Standby Mode

図 8-3. Simplified Recessive Common Mode Bias Unit and Receiver

#### 8.3.3 TXD Dominant Timeout (DTO)

During normal mode, the only mode where the CAN driver is active, the TXD DTO circuit prevents the local node from blocking network communication in the event of a hardware or software failure where TXD is held dominant longer than the timeout period  $t_{TXD\_DTO}$ . The TXD DTO circuit is triggered by a falling edge on TXD. If no rising edge is seen before the timeout period of the circuit,  $t_{TXD\_DTO}$ , the CAN driver is disabled. This frees the bus for communication between other nodes on the network. The CAN driver is reactivated when a recessive signal is seen on the TXD pin, thus clearing the dominant timeout. The receiver remains active and biased to  $V_{CC}/2$  and the RXD output reflects the activity on the CAN bus during the TXD DTO fault.

The minimum dominant TXD time allowed by the TXD DTO circuit limits the minimum possible transmitted data rate of the device. The CAN protocol allows a maximum of eleven successive dominant bits (on TXD) for the worst case, where five successive dominant bits are followed immediately by an error frame. The minimum transmitted data rate may be calculated using 式 1.

Minimum Data Rate = 11 bits / 
$$t_{TXD\_DTO}$$
 = 11 bits / 1.2 ms = 9.2 kbps (1)

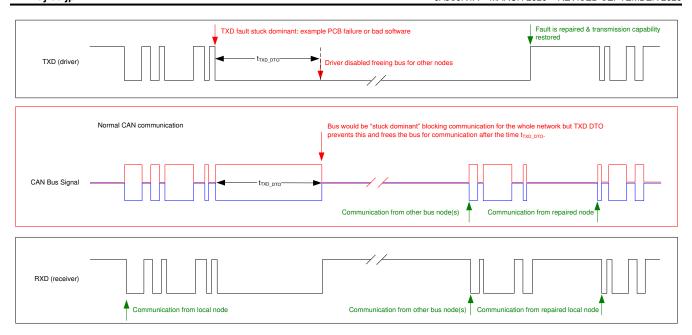


図 8-4. Example Timing Diagram for TXD Dominant Timeout

### 8.3.4 CAN Bus Short Circuit Current Limiting

The TCAN1046 has several protection features that limit the short circuit current when a CAN bus line is shorted. These include CAN driver current limiting in the dominant and recessive states and TXD dominant state timeout which prevents permanently having the higher short circuit current of a dominant state in case of a system fault. During CAN communication the bus switches between the dominant and recessive states, thus the short circuit current may be viewed as either the current during each bus state or as a DC average current. When selecting termination resistors or a common mode choke for the CAN design the average power rating, I<sub>OS(AVG)</sub>, should be used. The percentage dominant is limited by the TXD DTO and the CAN protocol which has forced state changes and recessive bits due to bit stuffing, control fields, and interframe space. These ensure there is a minimum amount of recessive time on the bus even if the data field contains a high percentage of dominant bits.

The average short circuit current of the bus depends on the ratio of recessive to dominant bits and their respective short circuit currents. The average short circuit current may be calculated using  $\sharp$  2.

#### Where:

- I<sub>OS(AVG)</sub> is the average short circuit current
- % Transmit is the percentage the node is transmitting CAN messages
- % Receive is the percentage the node is receiving CAN messages
- % REC Bits is the percentage of recessive bits in the transmitted CAN messages
- % DOM Bits is the percentage of dominant bits in the transmitted CAN messages
- I<sub>OS(SS)</sub> REC is the recessive steady state short circuit current
- I<sub>OS(SS)</sub> DOM is the dominant steady state short circuit current

This short circuit current and the possible fault cases of the network should be taken into consideration when sizing the power supply used to generate the transceivers  $V_{CC}$  supply.

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#### 8.3.5 Thermal Shutdown (TSD)

If the junction temperature of the TCAN1046 exceeds the thermal shutdown threshold,  $T_{TSD}$ , the device turns off the CAN driver circuitry and blocks the TXD to bus transmission path. The shutdown condition is cleared when the junction temperature of the device drops below  $T_{TSD}$ . The CAN bus pins are biased to  $V_{CC}/2$  during a TSD fault and the receiver to RXD path remains operational. The TCAN1046 TSD circuit includes hysteresis which prevents the CAN driver output from oscillating during a TSD fault.

### 8.3.6 Undervoltage Lockout

The supply pin,  $V_{CC}$ , has undervoltage detection that places the TCAN1046 into a protected state. This protects the bus during an undervoltage event on either supply pin.

表 8-1. Undervoltage Lockout

V <sub>CC</sub>	V <sub>CC</sub> DEVICE STATE		RXD PIN
> UV <sub>VCC</sub>	Normal	Per TXD	Mirrors bus
< UV <sub>VCC</sub>	Protected	High impedance Weak pull-down to ground <sup>(1)</sup>	High impedance

(1)  $V_{CC} = GND$ , see  $I_{LKG(OFF)}$  in Electrical Characteristics

Once the undervoltage condition is cleared and  $t_{\text{MODE}}$  has expired the TCAN1046 transitions to normal mode and the host controller can send and receive CAN traffic again.

#### 8.3.7 Unpowered Device

The TCAN1046 is designed to be an ideal passive or no load to the CAN bus if the device is unpowered. The bus pins were designed to have low leakage currents when the device is unpowered, so they do not load the bus. This is critical if some nodes of the network are unpowered while the rest of the of network remains operational.

The logic pins also have low leakage currents when the device is unpowered, so they do not load other circuits which may remain powered.

### 8.3.8 Floating pins

The TCAN1046 has internal pull-ups on critical pins which place the device into known states if the pin floats. This internal bias should not be relied upon by design though, especially in noisy environments, but instead should be considered a failsafe protection feature.

When a CAN controller supporting open-drain outputs is used an adequate external pull-up resistor must be chosen. This ensures that the TXD output of the CAN controller maintains acceptable bit time to the input of the CAN transceiver. See  $\frac{1}{5}$  8-2 for details on pin bias conditions.

表 8-2. Pin Bias

Pin	Pull-up or Pull-down	Comment		
TXD1 and TXD2	PHILID	Weakly biases TXD1 and TXD2 towards recessive to prevent bus blockage or TXD DTO triggering		
STB1 and STB2	Pull-up	Weakly biases STB1 and STB2 towards low-power standby mode prevent excessive system power		

#### 8.4 Device Functional Modes

### 8.4.1 Operating Modes

The TCAN1046 has two main operating modes; normal mode and standby mode. Operating mode selection is made by applying a high or low level to the STB1 and STB2 pins on the TCAN1046-Q1 device.

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Mirrors bus state

表 8-3. Operating Modes

STB	Device Mode	Driver	Receiver	RXD Pin				
High	Low current standby mode with bus wake-up	Disabled	Low-power receiver and bus monitor enable	High (recessive) until valid WUP is received See section 8.3.3.1				

Enabled

Enabled

#### 8.4.2 Normal Mode

Low

Normal Mode

This is the normal operating mode of the TCAN1046. The CAN driver and receiver are fully operational and CAN communication is bi-directional. The driver is translating a digital input on the TXD1 and TXD2 inputs to a differential output on the CANH1, CANL1 and CANH2, CANL2 bus pins. The receiver is translating the differential signal from CANH1, CANL1 and CANH2, CANL2 to a digital output on the RXD1 and RXD2 outputs.

### 8.4.3 Standby Mode

This is the low-power mode of the TCAN1046. The CAN driver and main receiver are switched off and bidirectional CAN communication is not possible. The low-power receiver and bus monitor circuits are enabled to allow for RXD wake-up requests via the CAN bus. A wake-up request is output to RXD1 or RXD2 depending on the channel which received the WUP as shown in  $\boxtimes$  8-5. The local CAN protocol controller should monitor RXD for transitions (high-to-low) and reactivate the device to normal mode by pulling the STB1 and STB2 pin low. The CAN bus pins are weakly pulled to GND in this mode; see  $\boxtimes$  8-2 and  $\boxtimes$  8-3.

### 8.4.3.1 Remote Wake Request via Wake-Up Pattern (WUP) in Standby Mode

The TCAN1046 supports a remote wake-up request on both CAN channels that is used to indicate to the host controller that the bus is active and the node should return to normal operation.

The device uses the multiple filtered dominant wake-up pattern (WUP) from the ISO 11898-2:2016 standard to qualify bus activity. Once a valid WUP has been received, the wake request is indicated to the controller by a falling edge and low period corresponding to a filtered dominant on the RXD1 or RXD2 output of the TCAN1046.

The WUP consists of a filtered dominant pulse, followed by a filtered recessive pulse, and finally by a second filtered dominant pulse. The first filtered dominant initiates the WUP, and the bus monitor then waits on a filtered recessive; other bus traffic does not reset the bus monitor. Once a filtered recessive is received the bus monitor is waiting for a filtered dominant and again, other bus traffic does not reset the bus monitor. Immediately upon reception of the second filtered dominant the bus monitor recognizes the WUP and drives the RXD1 or RXD2 output low every time an additional filtered dominant signal is received from the bus.

For a dominant or recessive to be considered filtered, the bus must be in that state for more than the  $t_{WK\_FILTER}$  time. Due to variability in  $t_{WK\_FILTER}$  the following scenarios are applicable. Bus state times less than  $t_{WK\_FILTER(MIN)}$  are never detected as part of a WUP and thus no wake request is generated. Bus state times between  $t_{WK\_FILTER(MIN)}$  and  $t_{WK\_FILTER(MAX)}$  may be detected as part of a WUP and a wake-up request may be generated. Bus state times greater than  $t_{WK\_FILTER(MAX)}$  are always detected as part of a WUP, and thus a wake request is always generated. See  $\boxtimes$  8-5 for the timing diagram of the wake-up pattern.

The pattern and  $t_{WK\_FILTER}$  time used for the WUP prevents noise and bus stuck dominant faults from causing false wake-up requests while allowing any valid message to initiate a wake-up request.

The ISO 11898-2:2016 standard has defined times for a short and long wake-up filter time. The  $t_{WK\_FILTER}$  timing for the device has been picked to be within the minimum and maximum values of both filter ranges. This timing has been chosen such that a single bit time at 500 kbps, or two back-to-back bit times at 1 Mbps triggers the filter in either bus state. Any CAN frame at 500 kbps or less would contain a valid WUP.

For an additional layer of robustness and to prevent false wake-ups, the device implements a wake-up timeout feature. For a remote wake-up event to successfully occur, the entire WUP must be received within the timeout value  $t \le t_{WK\_TIMEOUT}$ . If not, the internal logic is reset and the transceiver remains in its current state without waking up. The full pattern must then be transmitted again, conforming to the constraints mentioned in this section. See  $\boxtimes$  8-5 for the timing diagram of the wake-up pattern with wake timeout feature.



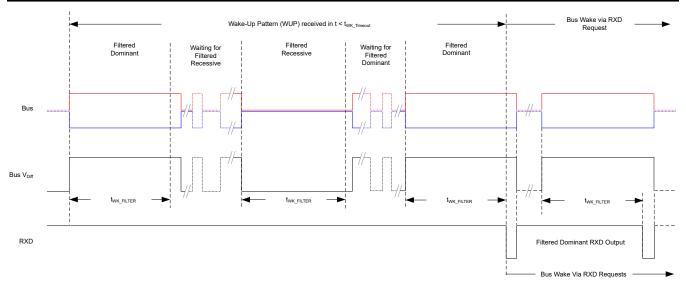


図 8-5. Wake-Up Pattern (WUP) with t<sub>WK\_TIMEOUT</sub>

### 8.4.4 Driver and Receiver Function

The digital logic input and output levels for the TCAN1046 are CMOS levels with respect to  $V_{CC}$  and are compatibility with protocol controllers having 5 V I/O levels.

表 8-4. Driver Function Table

Device Mode	TXD Input	Bus O	utputs	Driven Bus State <sup>(2)</sup>	
Device widge	1 AD IIIput	CANH	CANL		
Normal	Low	High	Low	Dominant	
Normal	High or open High im	High impedance	High impedance	Biased recessive <sup>(3)</sup>	
Standby X <sup>(1)</sup>		High impedance	High impedance	Weak pull-down to ground <sup>(3)</sup>	

- (1) X = irrelevant
- (2) For bus state and bias see ⊠ 8-2 and ⊠ 8-3
- (3) See R<sub>IN</sub> in *Electrical Characteristics*

表 8-5. Receiver Function Table Normal and Standby Mode

Device Mode	CAN Differential Inputs  V <sub>ID</sub> = V <sub>CANH</sub> - V <sub>CANL</sub>	Bus State	RXD Pin	
	V <sub>ID</sub> ≥ 0.9 V	Dominant	Low	
Normal	0.5 V < V <sub>ID</sub> < 0.9 V	Undefined	Undefined	
	V <sub>ID</sub> ≤ 0.5 V	Recessive	High	
	V <sub>ID</sub> ≥ 1.15 V	Dominant	High	
Standby	0.4 V < V <sub>ID</sub> < 1.15 V	Undefined	Low if a remote wake even occurred	
	V <sub>ID</sub> ≤ 0.4 V	Recessive	See 図 8-5	
Any	Open (V <sub>ID</sub> ≈ 0 V)	Open	High	

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## 9 Application and Implementation

#### Note

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## 9.1 Application Information

### 9.2 Typical Application

The TCAN1046 transceiver can be used in applications with a host controller or FPGA that includes the link layer portion of the CAN protocol. ☑ 9-1 shows a typical configuration for 5 V controller applications. The bus termination is shown for illustrative purposes.

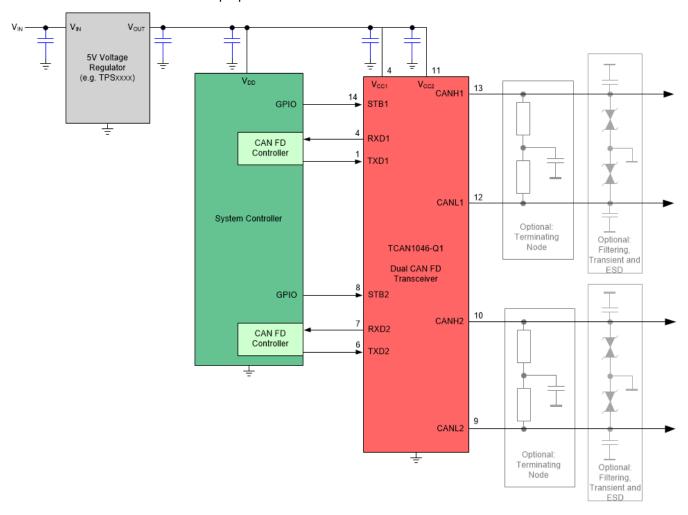


図 9-1. Transceiver Application Using 5 V I/O Connections

Product Folder Links: TCAN1046-Q1

#### 9.2.1 Design Requirements

#### 9.2.1.1 CAN Termination

Termination may be a single  $120-\Omega$  resistor at each end of the bus, either on the cable or in a terminating node. If filtering and stabilization of the common-mode voltage of the bus is desired then split termination may be used, see  $\boxtimes$  9-2. Split termination improves the electromagnetic emissions behavior of the network by filtering higher-frequency common-mode noise that may be present on the differential signal lines.

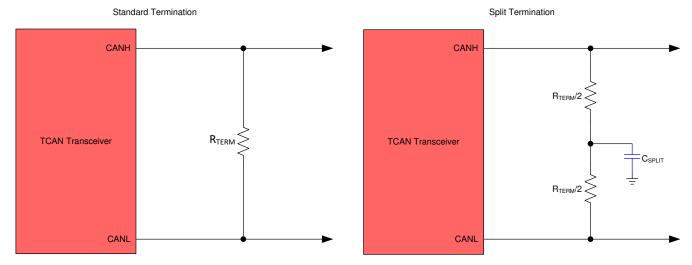


図 9-2. CAN Bus Termination Concepts

#### 9.2.2 Detailed Design Procedures

#### 9.2.2.1 Bus Loading, Length and Number of Nodes

A typical CAN application may have a maximum bus length of 40 meters and maximum stub length of 0.3 m. However, with careful design, users can have longer cables, longer stub lengths, and many more nodes to a bus. A high number of nodes requires a transceiver with high input impedance such as the TCAN1046.

Many CAN organizations and standards have scaled the use of CAN for applications outside the original ISO 11898-2 standard. They made system level trade off decisions for data rate, cable length, and parasitic loading of the bus. Examples of these CAN systems level specifications are ARINC 825, CANopen, DeviceNet, SAE J2284, SAE J1939, and NMEA 2000.

A CAN network system design is a series of tradeoffs. In the ISO 11898-2:2016 specification the driver differential output is specified with a bus load that can range from 50  $\Omega$  to 65  $\Omega$  where the differential output must be greater than 1.5 V. The TCAN1046 is specified to meet the 1.5 V requirement down to 50  $\Omega$  and is specified to meet 1.4 V differential output at 45 $\Omega$  bus load. The differential input resistance of the TCAN1046 is a minimum of 40 k $\Omega$ . If 100 TCAN1046 transceivers are in parallel on a bus, this is equivalent to a 400- $\Omega$  differential load in parallel with the nominal 60  $\Omega$  bus termination which gives a total bus load of approximately 52  $\Omega$ . Therefore, the TCAN1046 theoretically supports over 100 transceivers on a single bus segment. However, for a CAN network design margin must be given for signal loss across the system and cabling, parasitic loadings, timing, network imbalances, ground offsets and signal integrity thus a practical maximum number of nodes is often lower. Bus length may also be extended beyond 40 meters by careful system design and data rate tradeoffs. For example, CANopen network design guidelines allow the network to be up to 1 km with changes in the termination resistance, cabling, less than 64 nodes and significantly lowered data rate.

This flexibility in CAN network design is one of the key strengths of the various extensions and additional standards that have been built on the original ISO 11898-2 CAN standard. However, when using this flexibility, the CAN network system designer must take the responsibility of good network design to ensure robust network operation.



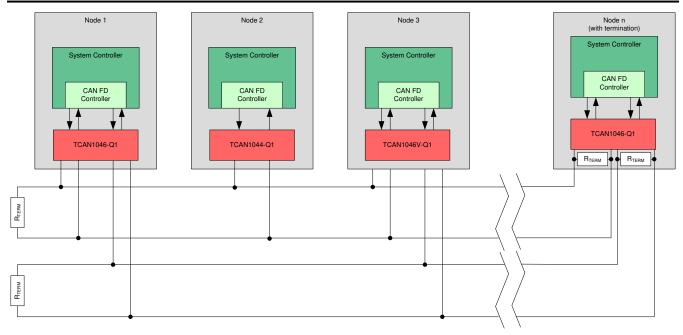
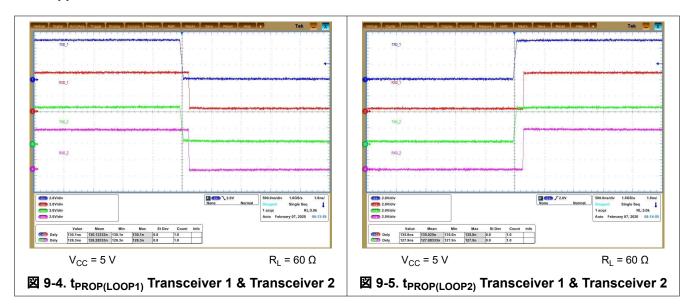


図 9-3. Typical CAN Bus

### 9.2.3 Application Curves



## 10 Power Supply Recommendations

The TCAN1046 dual transceiver is designed to operate with a main  $V_{CC1}$  and  $V_{CC2}$  input voltage supply range between 4.5 V and 5.5 V. The  $V_{CC}$  supply inputs must be well regulated. A decoupling capacitor, typically 100 nF, should be placed near the CAN transceiver's main  $V_{CC1}$  and  $V_{CC2}$  supply pins.

### 11 Layout

Robust and reliable CAN node design may require special layout techniques depending on the application and automotive design requirements. Since transient disturbances have high frequency content and a wide bandwidth, high-frequency layout techniques should be applied during PCB design.

## 11.1 Layout Guidelines

- Place the protection and filtering circuitry close to the bus connector, J1, to prevent transients, ESD, and noise from propagating onto the board. This layout example shows optional transient voltage suppression (TVS) diodes, D1 and D2, which may be implemented if the system-level requirements exceed the specified rating of the transceiver. This example also shows optional bus filter capacitors C4, C5, C6, and C8.
- Design the bus protection components in the direction of the signal path. Do not force the transient current to divert from the signal path to reach the protection device.
- Decoupling capacitors should be placed as close as possible to the supply pins V<sub>CC1</sub> and V<sub>CC2</sub> of the transceiver.
- Use at least two vias for supply and ground connections of bypass capacitors and protection devices to minimize trace and via inductance.

**Note** 

High frequency current follows the path of least impedance and not the path of least resistance.

• This layout example shows how split termination could be implemented on the CAN node. The termination is split into two pairs of resistors, R7, R8, R9, and R10, with the center or split tap of the termination connected to ground via capacitors C3 and C7. Split termination provides common mode filtering for the bus. See セクション 9.2.1.1, セクション 8.3.4, and 式 2 for information on termination concepts and power ratings needed for the termination resistor(s).

## 11.2 Layout Example

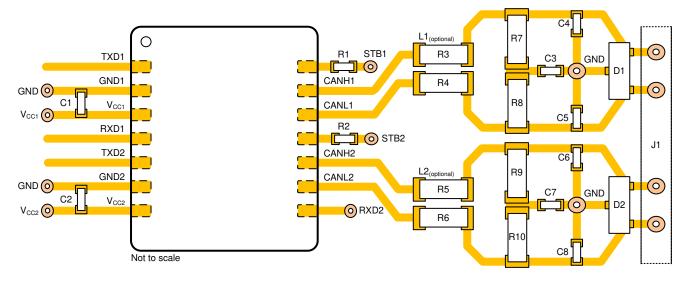


図 11-1. Layout Example



## 12 Device and Documentation Support

## 12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 12.2 サポート・リソース

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### 12.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 12.5 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

### 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Product Folder Links: TCAN1046-Q1

www.ti.com 9-Nov-2025

#### PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TCAN1046DMTRQ1	Active	Production	VSON (DMT)   14	3000   LARGE T&R	Yes	NIPDAU   SN	Level-2-260C-1 YEAR	-40 to 125	1046
TCAN1046DMTRQ1.A	Active	Production	VSON (DMT)   14	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	1046
TCAN1046DMTRQ1.B	Active	Production	VSON (DMT)   14	3000   LARGE T&R	-	Call TI	Call TI	-40 to 125	

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

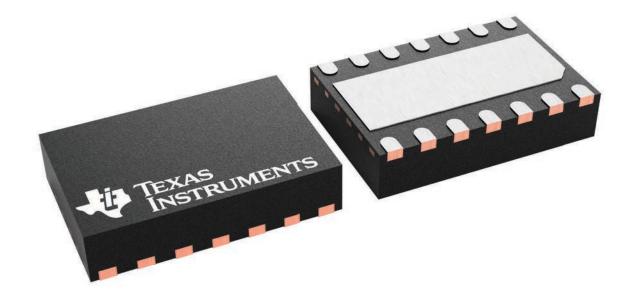
<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

3 x 4.5, 0.65 mm pitch

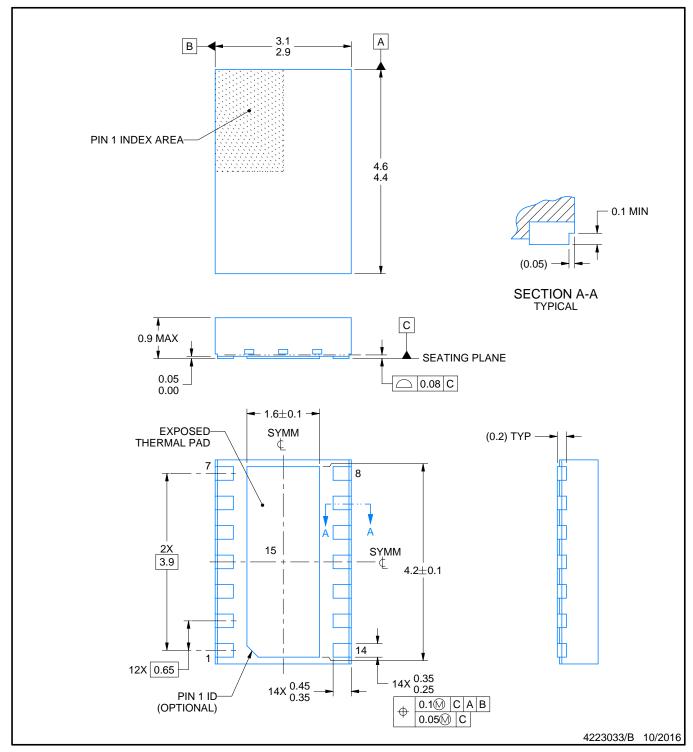
PLASTIC SMALL OUTLINE - NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



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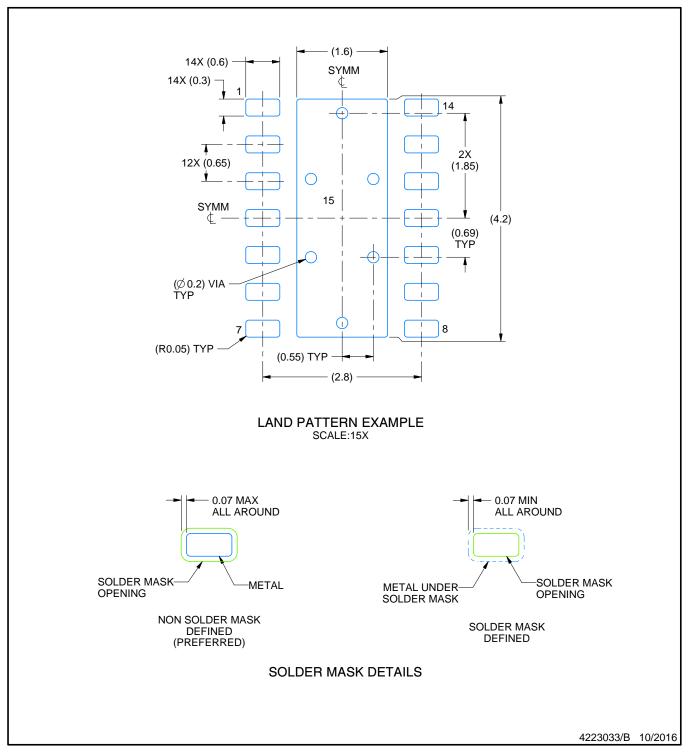
### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

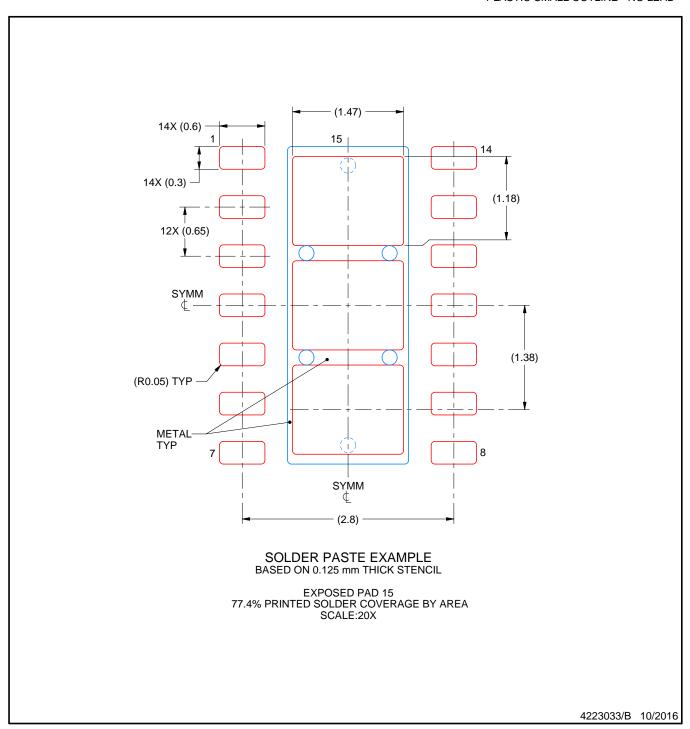




NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



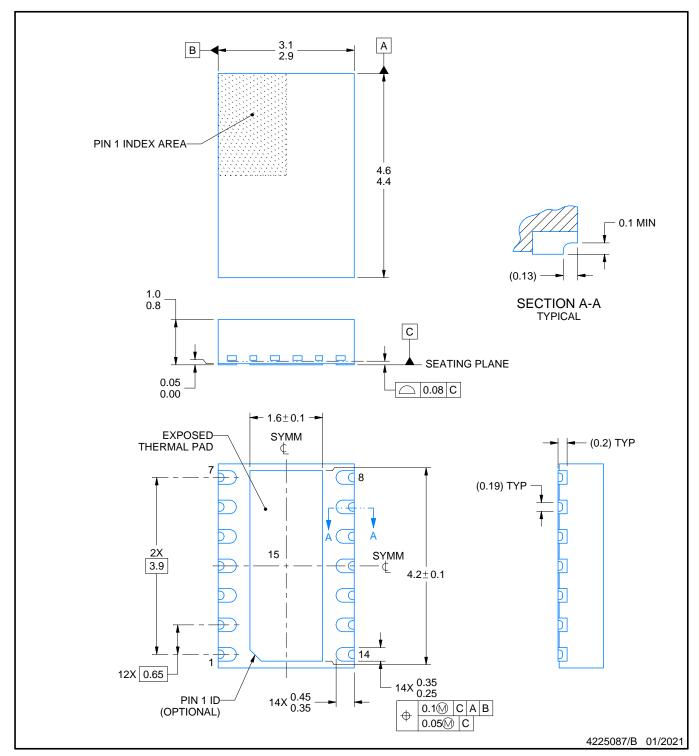


NOTES: (continued)

Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.







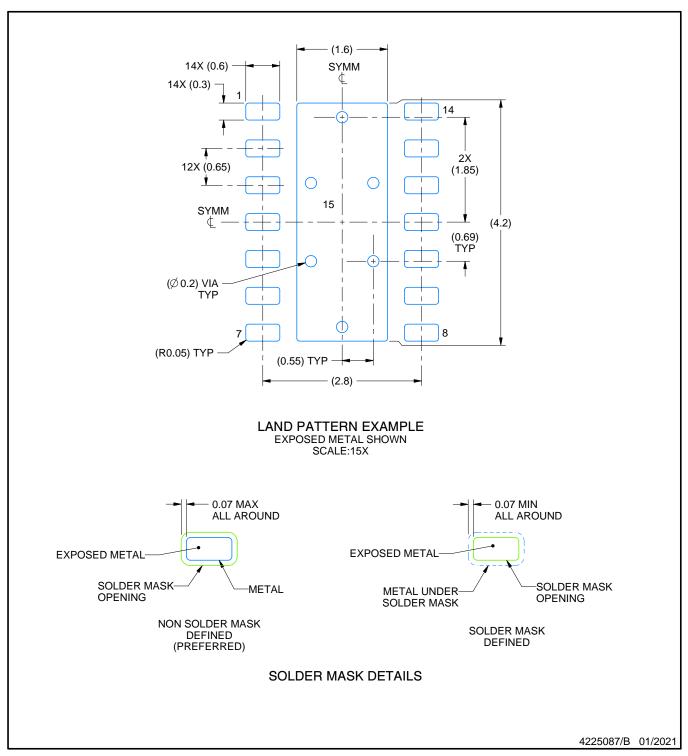
### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

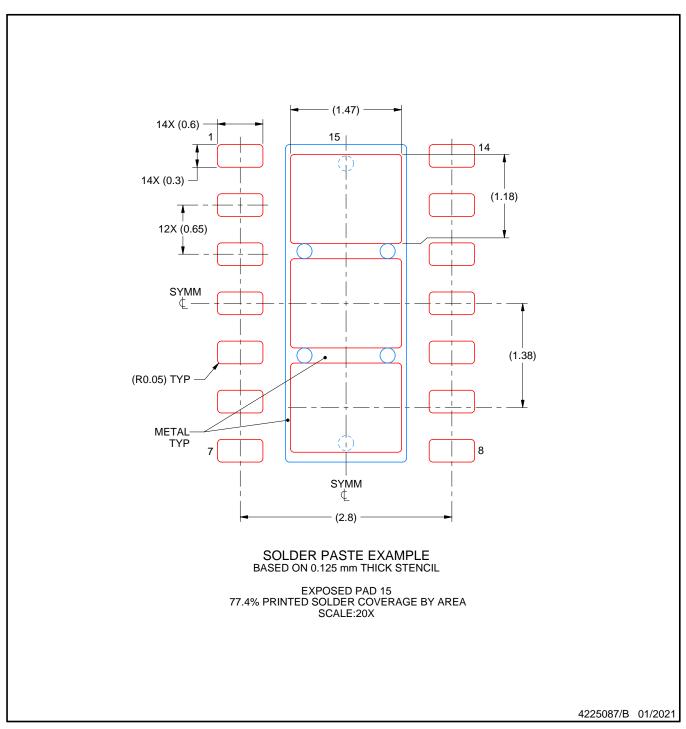




NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.





NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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